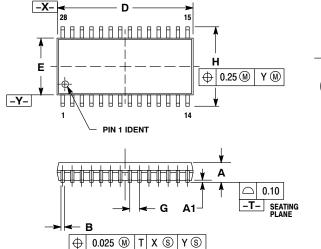
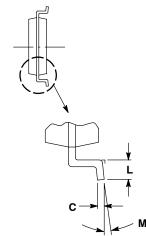




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DATE 23 SEP 2015





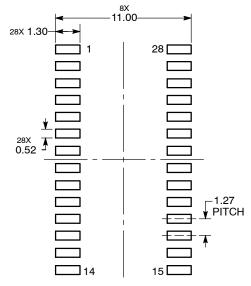
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD 3. PROTRUSION

 MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBER PR5OTRUSION SHALL NOT BE 0.13 TOTATL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| | MILLIMETERS | | |
|-----|-------------|-------|--|
| DIM | MIN | MAX | |
| Α | 2.35 | 2.65 | |
| A1 | 0.13 | 0.29 | |
| В | 0.35 | 0.49 | |
| С | 0.23 | 0.32 | |
| D | 17.80 | 18.05 | |
| E | 7.40 | 7.60 | |
| G | 1.27 BSC | | |
| Н | 10.05 | 10.55 | |
| L | 0.41 | 0.90 | |
| M | 0 ° | 80 | |

RECOMMENDED SOLDERING FOOTPRINT*



DIMENSIONS: MILLIMETERS

GENERIC MARKING DIAGRAM*



XXXXX = Specific Device Code

= Assembly Location

WL = Wafer Lot Υ = Year WW = Work Week

= Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

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|------------------|-------------------|---|-------------|
| DESCRIPTION: | SOIC-28 WIDE BODY | | PAGE 1 OF 1 |

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^{*}For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.